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| Application Number | | 10540968 | | | |
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| Filing Date | | 2005-09-26 | | | |
| First Named Inventor | Wei S | Wei Sun | | | |
| Art Unit | | 2128 | | | |
| Examiner Name | Hugh M. Jones | | | | |
| Attorney Docket Number | | D2027/20170 | | | |

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